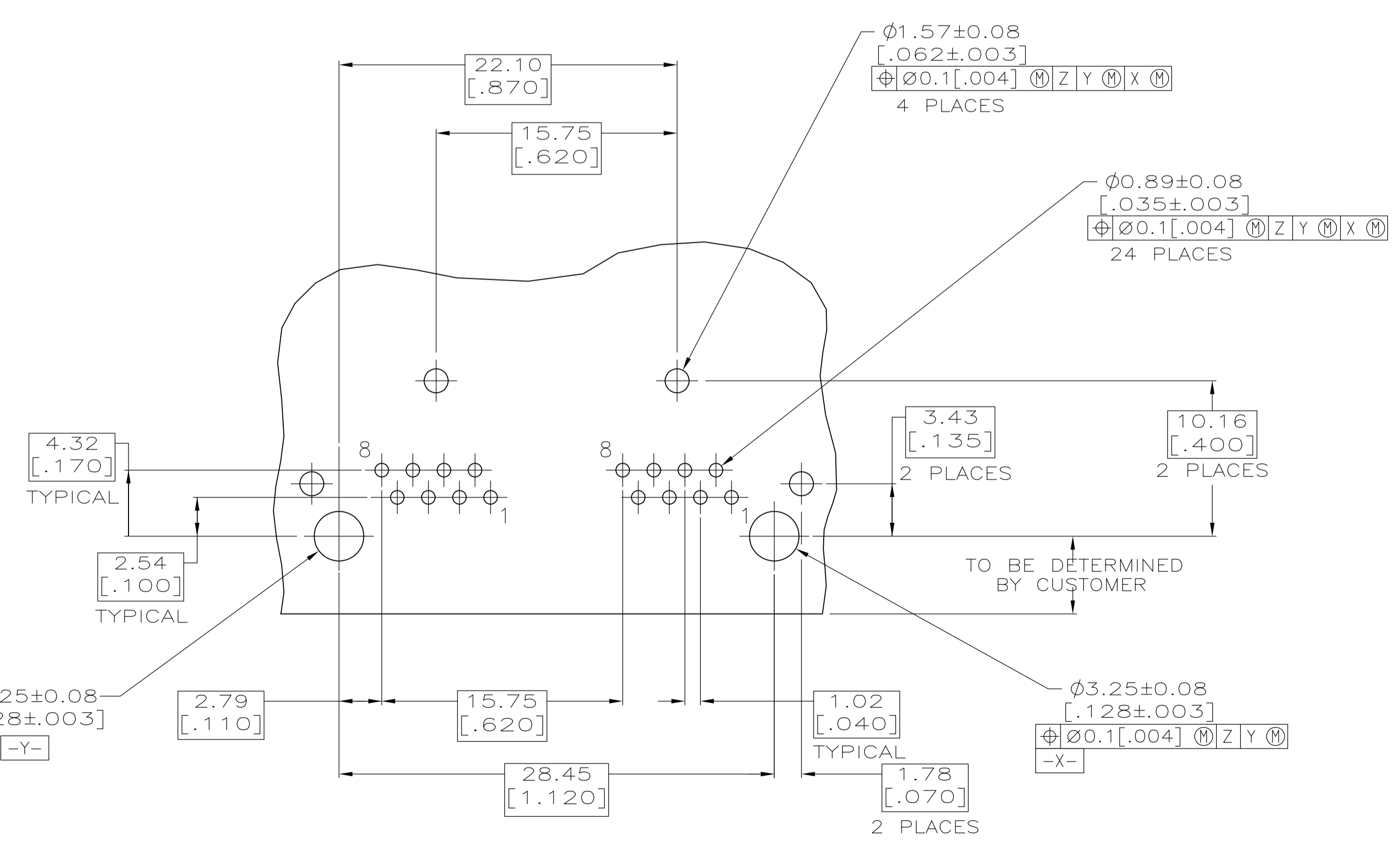


- △ MATERIAL: POLYESTER LCP
BLACK, UL94V-0; LEAD FREE IR REFLOW SOLDERING PROCESS COMPATIBLE.
TERMINALS - 0.36 [$.014$] THICK PHOS BRONZE PLATED WITH $3.81 \mu\text{m}$ [$.000150$] MINIMUM THICK MATTE TIN IN SOLDER AREA. $1.27 \mu\text{m}$ [$.000050$] MINIMUM GOLD IN LOCALIZED PLATE AREA. ENTIRE TERMINAL PLATED WITH $1.27 \mu\text{m}$ [$.000050$] MINIMUM THICK NICKEL.
SHIELD - 0.196 [$.0077$] THICK COPPER ZINC ALLOY PREPLATED WITH $1.27 \mu\text{m}$ [$.000050$] MINIMUM SATIN NICKEL WITH $2.03 \mu\text{m}$ [$.000080$] MINIMUM TIN POST DIPPED ON PCB GROUND TABS.
- 2. JACK CAVITY CONFORMS TO FCC RULES AND REGULATIONS PART 68, SUBPART F.
- △ SUGGESTED PANEL OPENING DIMENSIONS.
- △ SUGGESTED CLEARANCE BETWEEN TOP OF CONNECTOR AND TOP PANEL OPENING.
- △ THE CUSTOMER FEEDING DIRECTION IS THE OPPOSITE DIRECTION WITH 2170358-1



SUGGESTED PRINTED CIRCUIT BOARD LAYOUT (COMPONENT SIDE)

TAPE&REEL	2170358-2
TAPE&REEL	2170358-1
PACKAGE	PART NUMBER

THIS DRAWING IS A CONTROLLED DOCUMENT.		DIN J. JEREMY 29JUN2012		CIR J. JEREMY 29JUN2012		APVD G. ALEX 29JUN2012		NAME	
DIMENSIONS: mm [INCHES]		TOLERANCES UNLESS OTHERWISE SPECIFIED:		PRODUCT SPEC		APPLICATION SPEC		INVERTED MODULAR JACK ASSEMBLY, 1X2, SHIELDED, PANEL GROUND	
0 PLC ± -		1 PLC ± -		2 PLC ± 0.25[.01]		3 PLC ± 0.13[.005]		108-1163-4	
4 PLC ± -		ANGLES ± -		114-2154		SIZE		RESTRICTED TO	
MATERIAL △		FINISH △		WEIGHT -		A1 00779 C=2170358		-	
CUSTOMER DRAWING		SCALE 4:1		SHEET 1 of 1		REV A			

单击下面可查看定价，库存，交付和生命周期等信息

[>>TE Connectivity\(泰科\)](#)